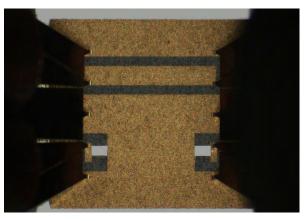
TCS-GSGSG-0225-0325 Calibration Substrate

The MPI TITAN™ TCS-GSGSG-0225-0325 Dual Calibration Substrate is designed to provide accurate probe tip calibration of MPI TITAN™ RF probes with ground-signal-ground-signal-ground (GSGSG) tips and the standard's layout is optimized implementing recommendations developed by the PlanarCal Consortium of twelve European organizations^[1]. It supports the industry standard Short-Open-Load-Thru (SOLT/TOSM) calibration method, as well as advanced Thru-Match-Reflect (TMR/LRM), Thru-Match-Reflect-Reflect (TMRR) and the NIST multiline Thru-Reflect-Line (mTRL) calibrations.

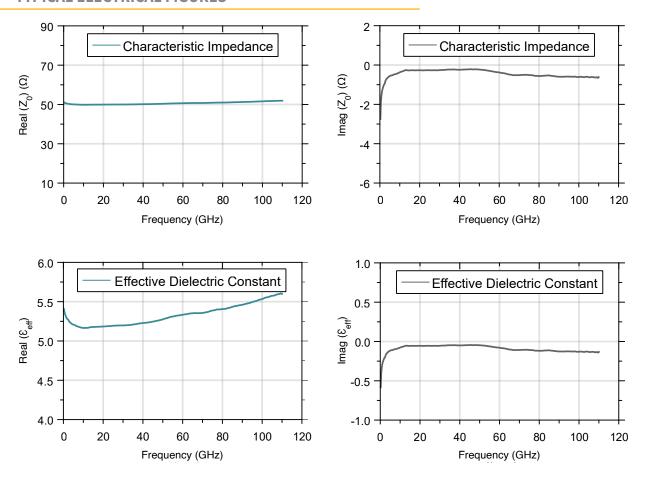
The TCS-GSGSG-0225-0325 contains the full set of coplanar transmission lines for mTRL calibrations up to 110 GHz.



Two opposing GSGSG TITAN™ Dual Probes in separation after touching the Thru (Adj Load) Standard and using 10 µm vertical over-

The unique approach of terminating idle RF probe ports by an Adjacent Load element implemented for MPI's TCS dual calibration substrates family drastically improves calibration accuracy at the mmW frequency range^[2].

TYPICAL ELECTRICAL FIGURES



SUBSTRATE CHARACTERISTICS

Material	Alumina
Size	16.7 mm x 12.7 mm
Thickness	254 μm
Design or standards	Coplanar
Probe configuration	GSGSG
Supported probe pitch	225 to 325 μm
Number of calibration and verification lines	3
Calibration verification elements	yes
Supported calibration methods	TOSM (SOLT), TMR, LRM, SOLR, TMRR, TRL and mTRL
Typical resistance of the load	50 Ω
Typical load trimming accuracy error	± 0.3 %
Open standard	Au pads on substrate
Recommended overtravel for TITAN™ probes	10 μm

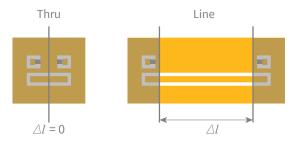
ELECTRICAL CHARACTERISTICS OF CPW LINE STANDARDS

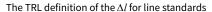
Nominal capacitance per unit length, pF/cm	1.52
Nominal characteristic impedance @20 GHz	50 Ω
Effective dielectric constant @20 GHz, real part	5.31
Velocity factor @20 GHz	0.434
Parameters of the simplified model of line losses	
Reference loss, dB	0.26
Reference delay, ps	30
Reference frequency, GHz	30
Electrical length of line, ps	
Thru (Adj Load)	6.92
Thru (Adj Load) 1 (0201,0205)	10.14
Thru (Adj Load) 2 (0301,0305)	15.52
Thru (Adj Load) 3 (0401,0405)	29.81
Dual Thru (0103)	7.06
Vertical Thru (0402 - 0404)	4.73

CALIBRATION ACCURACY USING NIST MULTILINE THRU-REFLECT-LINE (mTRL) PROCESS

The mTRL calibration kit can be easily designed and fabricated using the same semiconductor process as the DUT. Customized "On-wafer" mTRL calibration kits eliminate the need for de-embedding the DUT measurement results from parasitic impedances of the device contact pads. The mTRL is the only method that delivers trustable calibration results at measurement frequencies above 220 GHz.

The mTRL algorithm requires multiple Line standards of different physical lengths and always treats the first Line (the "Thru") standard as a zero-length line. As a result, the length of each subsequent Line standard, Delta-I, is defined with respect to the length of the Thru (the first line).







The MP80-DX MicroPositioner with the digital micrometer on the X axes.

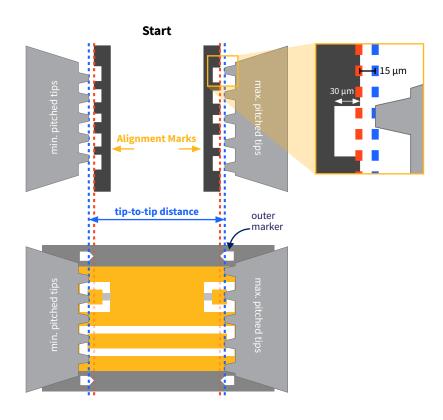
Standard type, (Name)	Physical length, μm	Effective length l, μm	Δl, μm
Thru (Adj Load)	950	900	0
Thru (Adj Load) Line 1 (0201,0205)	1370	1320	420
Thru (Adj Load) Line 2 (0301,0305)	2070	2020	1120
Thru (Adj Load) Line 3 (0401,0405)	3930	3880	2980

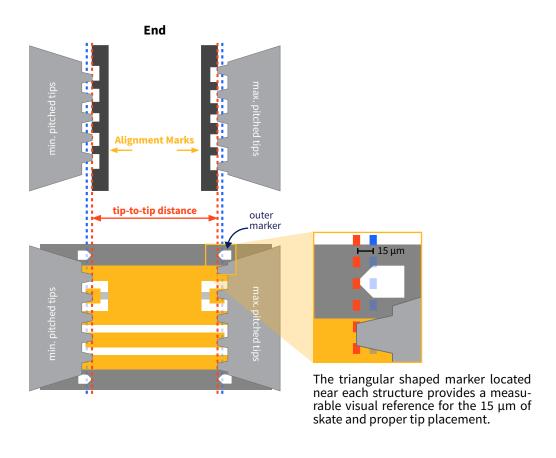
PROBE TIP POSITIONING AND ALIGNMENT MARKS

Consistent and accurate placement of the probe tips on calibration structures is critical for accurate and repeatable system calibration. The MPI TITAN™ TCS calibration substrate simplifies correct probe-tip-to-structure-alignment by providing special pre-alignment structures for the end user. The pre-alignment structures (Alignment Marks) enable the user to contact the Short, Open, Load and Thru structures in the correct location for consistent calibration results. For the Short, Open and Load, correct alignment is at the middle of each pad (Y-axis or relative to the direction of probe tip skate). For the Thru/Line elements, the correct alignment is 10-15 µm inward from each end of line so the two opposing probes are apart by the specified distance that corresponds to the effective length of the element.

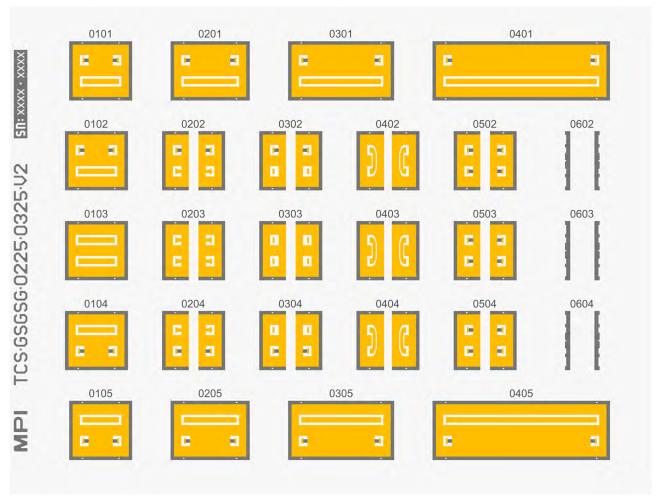
The unique saw-tooth like Alignment Marks (structures # 0602-0604) and cone-shaped Outer Marker found on the TCS calibration substrate are designed for proper probe-tip-to-calibration-structure edge adjustment. The edge of the Alignment Marks (as highlighted by the red dashed line in Figure below) corresponds to the endpoint on a Short, Open, Load or Thru/Line structure when the proper amount of probe overtravel and resulting 10-15 μm of probe tip skate has been used. Skate begins from the moment the probe tips first make contact to the substrate (See the blue dashed line in Figure below) where initial tip contact should occur.

The operator should aim for and use the blue dashed line and cone of the Outer Marker as a visual reference/ starting point for $10-15~\mu m$ of probe tip skate. Minimal vertical overtravel (less than $20~\mu m$ typically) is needed so the tips skate from the blue dashed line (outside saw tooth opening) to the red dashed line (at the edge, but not into the saw tooth opening) as the stopping point. When done properly, two opposing probes are at the correct physical distance and rotational alignment when both are resting at the red dashed line in the example (at the edge of, but not inside, the saw tooth openings on the Alignment Marks).





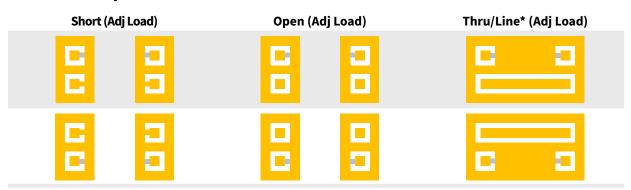
SUBSTRATE LAYOUT



^{*}Location reference elements is 0102.

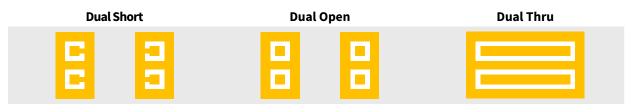
STANDARD ELEMENTS

Standards with adjacent loads



^{*}Lines: three choices of transmission lines provided, each with different physical and electrical lengths.

Dual standards





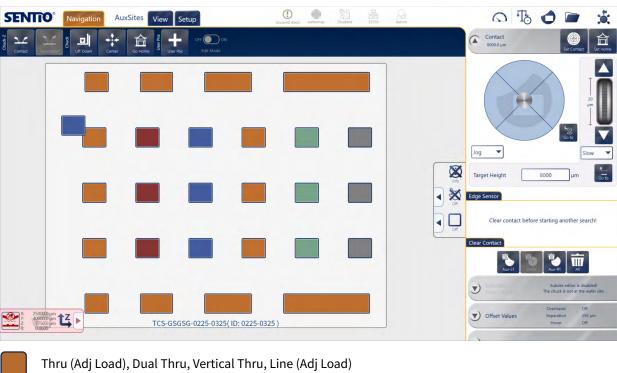
AUTOMATED NAVIGATION IN SENTIO®

SENTIO® probe station software from MPI Corporation is powerful Graphical User Interface (GUI) software to take your semiconductor testing to the next level. With unparalleled usability, multi-touch capabilities, and a customizable dashboard, SENTIO® software is designed to make your testing and microwave probe calibration processes more efficient and productive. Picture in Picture and QAlibria® inside provide advanced data analysis tools, while built-in intelligence streamlines your testing processes and keeps your probes and devices safe.

Connectivity and upgradability mean you're always connected and up to date with the latest features, while scalability ensures that SENTIO® software can grow with your business.

SENTIO® and QAlibria® integrate seamlessly with the structure mapping of your TCS calibration substrate, making standards navigation the calibration process automated and easy even for inexperienced operators.

The map of the TCS-GSGSG-0225-0325 substrate in SENTIO®



Short (Adj Load), Dual Short

Open (Adj Load), Dual Open, Open on bare ceramic or in Separation

Dual Load

Alignment Mark

STANDARDS

Thru Standa	rds with Adjacent Load			
Name	Type	X μm	Yμm	Spacing µm
0102	Thru (Adj Load)	0	0	900
0104	Thru (Adj Load)	0	-4680	900
0101	Thru (Adj Load)	110	2340	900
0105	Thru (Adj Load)	110	-7020	900

Line Stand	<u>lards with</u>	<u>Adjacent</u>	Load

Name	Type	X μm	Yμm	Spacing µm
0201	Line1 (Adj Load)	2750	2340	1320
0301	Line2 (Adj Load)	5810	2340	2020
0401	Line3 (Adj Load)	9570	2340	3880
0205	Line1 (Adj Load)	2750	-7020	1320
0305	Line2 (Adj Load)	5810	-7020	2020
0405	Line3 (Adj Load)	9570	-7020	3880

Short Standards with Adjacent Load

Name	Type	Xμm	Yμm	Spacing µm
0202	Short (Adj Load)	2530	0	900
0204	Short (Adj Load)	2530	-4680	900

Open with Adjacent Load

Name	Type	X μm	Yμm	Spacing µm
0302	Open (Adj Load)	5060	0	900
0304	Open (Adj Load)	5060	-4680	900

Dual Calibration Standards

Type	Xμm	Yμm	Spacing µm
Dual Thru	0	-2340	900
Dual Short	2530	-2340	900
Dual Open	5060	-2340	900
Dual Load	10120	0	900
Dual Load	10120	-2340	900
Dual Load	10120	-4680	900
	Dual Thru Dual Short Dual Open Dual Load Dual Load	Dual Thru 0 Dual Short 2530 Dual Open 5060 Dual Load 10120 Dual Load 10120	Dual Thru 0 -2340 Dual Short 2530 -2340 Dual Open 5060 -2340 Dual Load 10120 0 Dual Load 10120 -2340

Vertical (Loop-Back) Thru Standards

Name	Туре	X μm	Yμm	Spacing µm
0402	Vertical Thru	7590	0	900
0403	Vertical Thru	7590	-2340	900
0404	Vertical Thru	7590	-4680	900

Probe Alignment Elements

Name	Туре	Xμm	Y μm	Spacing µm
0602	Alignment Mark	12650	0	900
0603	Alignment Mark	12650	-2340	900
0604	Alignment Mark	12650	-4680	900

CALIBRATION COEFFICIENTS FOR THE TITAN™ DUAL PROBES

GSGSG Configuration

Pitch	Model	C-Open, fF	L-Short, pH	L-Term, pH
225 μm	26, 40, 50 GHz, Standard	9.0	81	66
250 μm	26, 40, 50 GHz, Standard	8.5	81	68
325 μm	26, 40, 50 GHz, Standard	9.2	87	73

GSGSG Configuration, for the Keysight VNA

		C-Open, fF	L-Short, pH		Load*	
Pitch	Model	C, fF	L, pH	R, Ohm	Offset Z ₀ , Ohm	Offset delay, ps
225 μm	26, 40, 50, 67 GHz, Standard	9.0	81	50	500	0.133
250 μm	26, 40, 50, 67 GHz, Standard	8.5	81	50	500	0.137
325 μm	26, 40, 50, 67 GHz, Standard	9.2	87	50	500	0.147

^{*}Use both offset impedance and offset delay parameters.

REFERENCES

- [1] M. Spirito, U. Arz, G. N. Phung, F. J. Schmückle, W. Heinrich, and R. Lozar, "Guidelines for the design of calibration substrates, including the suppression of parasitic modes for frequencies up to and including 325 GHz," in "EMPIR 14IND02 PlanarCal," Physikalisch-Technische Bundesanstalt (PTB), 2018.
- [2] H.-C. Fu, K. Jung. "Improve RF Dual Probe Calibration Accuracy with Peer-Terminated Standard", in 2024 IEEE / MTT-S International Microwave Symposium IMS 2024, Washington, DC, USA, 16-24 June, 2024.

See MPI Corporation's Terms and Conditions of Sale for more details.

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